

AMENDMENTS TO THE CLAIMS:

The listing of claims will replace all prior versions, and listing, of claims in the application:

LISTING OF CLAIMS

Claims 1-8 (canceled).

- 1 9. (Currently Amended) A photoresist laminate comprising:
 - 2 a substrate;
 - 3 a photoresist pattern with a reinforcing section formed by using an exposure and a
 - 4 developing solution,
 - 5 a sublayer film provided between the substrate and the photoresist pattern, the sublayer
 - 6 film being soluble in a developing solution used to form the photoresist pattern; and
 - 7 wherein there is provided in said photoresist pattern, a line section and [[a]] reinforcing
 - 8 section that continues to said line section, and [[that]] said reinforcing section has a greater width
 - 9 than a line width of said line section.

Claims 10-13 (canceled).